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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	16
Program Memory Size	1.75KB (1K x 14)
Program Memory Type	FLASH
EEPROM Size	128 x 8
RAM Size	224 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	18-SOIC (0.295", 7.50mm Width)
Supplier Device Package	18-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf627at-i-so

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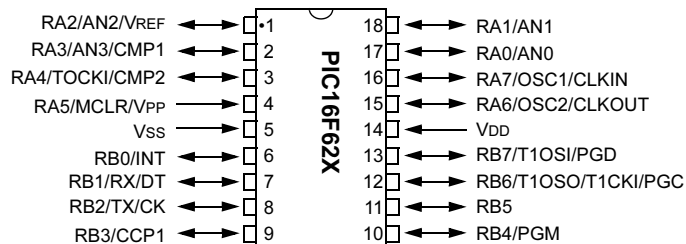


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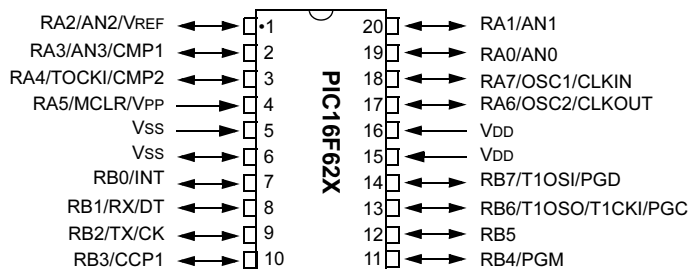
PIC16F62X

Pin Diagrams

PDIP, SOIC



SSOP



Device Differences

Device	Voltage Range	Oscillator	Process Technology (Microns)
PIC16F627	3.0 - 5.5	(Note 1)	0.7
PIC16F628	3.0 - 5.5	(Note 1)	0.7
PIC16LF627	2.0 - 5.5	(Note 1)	0.7
PIC16LF628	2.0 - 5.5	(Note 1)	0.7

Note 1: If you change from this device to another device, please verify oscillator characteristics in your application.

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TABLE 3-4: SPECIAL FUNCTION REGISTERS SUMMARY BANK 3

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR Reset ⁽¹⁾	Details on Page
Bank 3											
180h	INDF	Addressing this location uses contents of FSR to address data memory (not a physical register)								xxxx xxxx	25
181h	OPTION	RBP \overline{U}	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	20
182h	PCL	Program Counter's (PC) Least Significant Byte								0000 0000	25
183h	STATUS	IRP	RP1	RP0	\overline{TO}	\overline{PD}	Z	DC	C	0001 1xxx	19
184h	FSR	Indirect data memory address pointer								xxxx xxxx	25
185h	—	Unimplemented								—	—
186h	TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	1111 1111	34
187h	—	Unimplemented								—	—
188h	—	Unimplemented								—	—
189h	—	Unimplemented								—	—
18Ah	PCLATH	—	—	—	Write buffer for upper 5 bits of program counter					---0 0000	25
18Bh	INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	21
18Ch	—	Unimplemented								—	—
18Dh	—	Unimplemented								—	—
18Eh	—	Unimplemented								—	—
18Fh	—	Unimplemented								—	—
190h	—	Unimplemented								—	—
191h	—	Unimplemented								—	—
192h	—	Unimplemented								—	—
193h	—	Unimplemented								—	—
194h	—	Unimplemented								—	—
195h	—	Unimplemented								—	—
196h	—	Unimplemented								—	—
197h	—	Unimplemented								—	—
198h	—	Unimplemented								—	—
199h	—	Unimplemented								—	—
19Ah	—	Unimplemented								—	—
19Bh	—	Unimplemented								—	—
19Ch	—	Unimplemented								—	—
19Dh	—	Unimplemented								—	—
19Eh	—	Unimplemented								—	—
19Fh	—	Unimplemented								—	—

Legend: — = Unimplemented locations read as '0', u = unchanged, x = unknown, q = value depends on condition, shaded = unimplemented

Note 1: For the Initialization Condition for Registers Tables, refer to Table 14-7 and Table 14-8 on page 98.

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3.2.2.4 PIE1 Register

This register contains interrupt enable bits.

REGISTER 3-4: PIE1 REGISTER (ADDRESS: 8Ch)

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
EEIE	CMIE	RCIE	TXIE	—	CCP1IE	TMR2IE	TMR1IE
bit 7							bit 0

- bit 7 **EEIE:** EE Write Complete Interrupt Enable Bit
1 = Enables the EE write complete interrupt
0 = Disables the EE write complete interrupt
- bit 6 **CMIE:** Comparator Interrupt Enable bit
1 = Enables the comparator interrupt
0 = Disables the comparator interrupt
- bit 5 **RCIE:** USART Receive Interrupt Enable bit
1 = Enables the USART receive interrupt
0 = Disables the USART receive interrupt
- bit 4 **TXIE:** USART Transmit Interrupt Enable bit
1 = Enables the USART transmit interrupt
0 = Disables the USART transmit interrupt
- bit 3 **Unimplemented:** Read as '0'
- bit 2 **CCP1IE:** CCP1 Interrupt Enable bit
1 = Enables the CCP1 interrupt
0 = Disables the CCP1 interrupt
- bit 1 **TMR2IE:** TMR2 to PR2 Match Interrupt Enable bit
1 = Enables the TMR2 to PR2 match interrupt
0 = Disables the TMR2 to PR2 match interrupt
- bit 0 **TMR1IE:** TMR1 Overflow Interrupt Enable bit
1 = Enables the TMR1 overflow interrupt
0 = Disables the TMR1 overflow interrupt

Legend:

R = Readable bit
-n = Value at POR

W = Writable bit
'1' = Bit is set

U = Unimplemented bit, read as '0'
'0' = Bit is cleared x = Bit is unknown

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TABLE 5-2: SUMMARY OF REGISTERS ASSOCIATED WITH PORTA⁽¹⁾

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	Value on All Other RESETS
05h	PORTA	RA7	RA6	RA5	RA4	RA3	RA2	RA1	RA0	xxxx 0000	xxxxu 0000
85h	TRISA	TRISA7	TRISA6	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	1111 1111	1111 1111
1Fh	CMCON	C2OUT	C1OUT	C2INV	C1INV	CIS	CM2	CM1	CM0	0000 0000	0000 0000
9Fh	VRCON	VREN	VROE	VRR	—	VR3	VR2	VR1	VR0	000- 0000	000- 0000

Legend: — = Unimplemented locations, read as '0', u = unchanged, x = unknown

Note 1: Shaded bits are not used by PORTA.

5.2 PORTB and TRISB Registers

PORTB is an 8-bit wide bi-directional port. The corresponding data direction register is TRISB. A '1' in the TRISB register puts the corresponding output driver in a Hi-impedance mode. A '0' in the TRISB register puts the contents of the output latch on the selected pin(s).

PORTB is multiplexed with the external interrupt, USART, CCP module and the TMR1 clock input/output. The standard port functions and the alternate port functions are shown in Table 5-3. Alternate port functions override TRIS setting when enabled.

Reading PORTB register reads the status of the pins, whereas writing to it will write to the port latch. All write operations are read-modify-write operations. So a write to a port implies that the port pins are first read, then this value is modified and written to the port data latch.

Each of the PORTB pins has a weak internal pull-up ($\approx 200 \mu\text{A}$ typical). A single control bit can turn on all the pull-ups. This is done by clearing the RBPU (OPTION<7>) bit. The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on Power-on Reset.

Four of PORTB's pins, RB<7:4>, have an interrupt-on-change feature. Only pins configured as inputs can cause this interrupt to occur (i.e., any RB<7:4> pin configured as an output is excluded from the interrupt-on-change comparison). The input pins (of RB7:RB4) are compared with the old value latched on the last read of PORTB. The "mismatch" outputs of RB7:RB4 are OR'ed together to generate the RBIF interrupt (flag latched in INTCON<0>).

This interrupt can wake the device from SLEEP. The user, in the interrupt service routine, can clear the interrupt in the following manner:

- Any read or write of PORTB. This will end the mismatch condition.
- Clear flag bit RBIF.

A mismatch condition will continue to set flag bit RBIF. Reading PORTB will end the mismatch condition and allow flag bit RBIF to be cleared.

This interrupt on mismatch feature, together with software configurable pull-ups on these four pins allow easy interface to a key pad and make it possible for wake-up on key-depression. (See AN552)

Note: If a change on the I/O pin should occur when a read operation is being executed (start of the Q2 cycle), then the RBIF interrupt flag may not get set.

The interrupt-on-change feature is recommended for wake-up on key depression operation and operations where PORTB is only used for the interrupt-on-change feature. Polling of PORTB is not recommended while using the interrupt-on-change feature.

7.1 Timer1 Operation in Timer Mode

Timer mode is selected by clearing the TMR1CS (T1CON<1>) bit. In this mode, the input clock to the timer is $F_{osc}/4$. The synchronize control bit T1SYNC (T1CON<2>) has no effect since the internal clock is always in sync.

7.2 Timer1 Operation in Synchronized Counter Mode

Counter mode is selected by setting bit TMR1CS. In this mode the timer increments on every rising edge of clock input on pin RB7/T1OSI when bit T1OSCEN is set or pin RB6/T1OSO/T1CKI when bit T1OSCEN is cleared.

If T1SYNC is cleared, then the external clock input is synchronized with internal phase clocks. The synchronization is done after the prescaler stage. The prescaler stage is an asynchronous ripple-counter.

In this configuration, during SLEEP mode, Timer1 will not increment even if the external clock is present, since the synchronization circuit is shut off. The prescaler however will continue to increment.

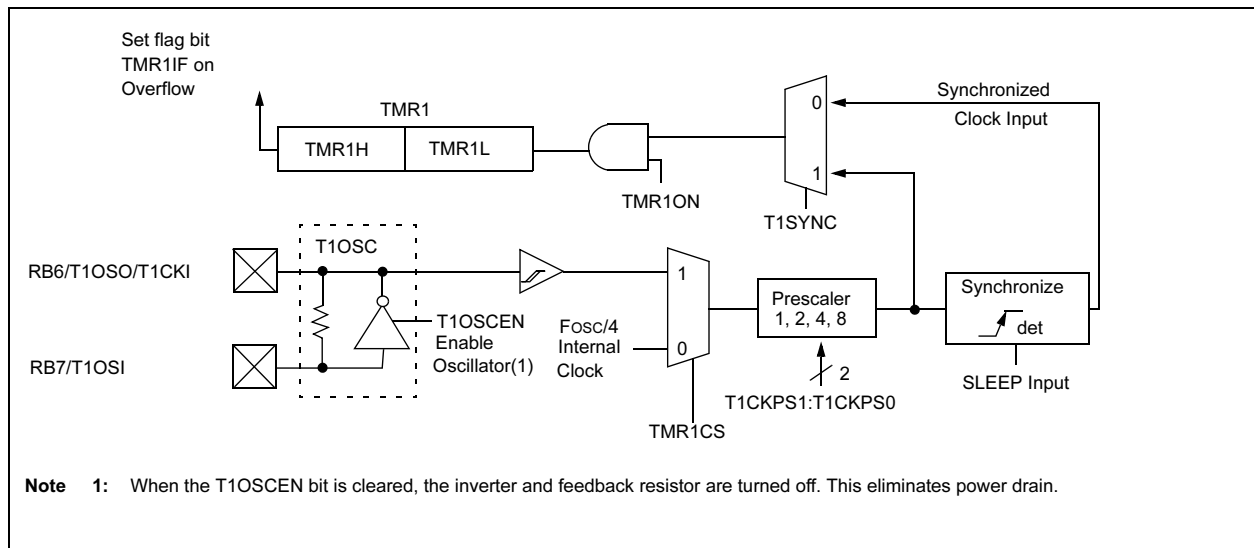
7.2.1 EXTERNAL CLOCK INPUT TIMING FOR SYNCHRONIZED COUNTER MODE

When an external clock input is used for Timer1 in Synchronized Counter mode, it must meet certain requirements. The external clock requirement is due to internal phase clock (T_{osc}) synchronization. Also, there is a delay in the actual incrementing of TMR1 after synchronization.

When the prescaler is 1:1, the external clock input is the same as the prescaler output. The synchronization of T1CKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks. Therefore, it is necessary for T1CKI to be high for at least $2T_{osc}$ (and a small RC delay of 20 ns) and low for at least $2T_{osc}$ (and a small RC delay of 20 ns). Refer to the appropriate electrical specifications, parameters 45, 46, and 47.

When a prescaler other than 1:1 is used, the external clock input is divided by the asynchronous ripple-counter type prescaler so that the prescaler output is symmetrical. In order for the external clock to meet the sampling requirement, the ripple-counter must be taken into account. Therefore, it is necessary for T1CKI to have a period of at least $4T_{osc}$ (and a small RC delay of 40 ns) divided by the prescaler value. The only requirement on T1CKI high and low time is that they do not violate the minimum pulse width requirements of 10 ns). Refer to the appropriate electrical specifications, parameters 40, 42, 45, 46, and 47.

FIGURE 7-1: TIMER1 BLOCK DIAGRAM



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NOTES:

9.6 Comparator Interrupts

The Comparator Interrupt flag is set whenever there is a change in the output value of either comparator. Software will need to maintain information about the status of the output bits, as read from CMCON<7:6>, to determine the actual change that has occurred. The CMIF bit, PIR1<6>, is the Comparator Interrupt Flag. The CMIF bit must be RESET by clearing '0'. Since it is also possible to write a '1' to this register, a simulated interrupt may be initiated.

The CMIE bit (PIE1<6>) and the PEIE bit (INTCON<6>) must be set to enable the interrupt. In addition, the GIE bit must also be set. If any of these bits are clear, the interrupt is not enabled, though the CMIF bit will still be set if an interrupt condition occurs.

Note: If a change in the CMCON register (C1OUT or C2OUT) should occur when a read operation is being executed (start of the Q2 cycle), then the CMIF (PIR1<6>) interrupt flag may not get set.

The user, in the interrupt service routine, can clear the interrupt in the following manner:

- a) Any write or read of CMCON. This will end the mismatch condition.
- b) Clear flag bit CMIF.

A mismatch condition will continue to set flag bit CMIF. Reading CMCON will end the mismatch condition, and allow flag bit CMIF to be cleared.

9.7 Comparator Operation During SLEEP

When a comparator is active and the device is placed in SLEEP mode, the comparator remains active and the interrupt is functional if enabled. This interrupt will wake-up the device from SLEEP mode when enabled. While the comparator is powered-up, higher SLEEP currents than shown in the power-down current specification will occur. Each comparator that is operational will consume additional current as shown in the comparator specifications. To minimize power consumption while in SLEEP mode, turn off the comparators, CM<2:0> = 111, before entering SLEEP. If the device wakes-up from SLEEP, the contents of the CMCON register are not affected.

9.8 Effects of a RESET

A device RESET forces the CMCON register to its RESET state. This forces the Comparator module to be in the comparator RESET mode, CM2:CM0 = 000. This ensures that all potential inputs are analog inputs. Device current is minimized when analog inputs are present at RESET time. The comparators will be powered-down during the RESET interval.

9.9 Analog Input Connection Considerations

A simplified circuit for an analog input is shown in Figure 9-4. Since the analog pins are connected to a digital output, they have reverse biased diodes to VDD and VSS. The analog input therefore, must be between VSS and VDD. If the input voltage deviates from this range by more than 0.6V in either direction, one of the diodes is forward biased and a latchup may occur. A maximum source impedance of 10 kΩ is recommended for the analog sources. Any external component connected to an analog input pin, such as a capacitor or a Zener diode, should have very little leakage current.

PIC16F62X

EXAMPLE 10-1: VOLTAGE REFERENCE CONFIGURATION

```

MOVLW    0x02        ; 4 Inputs Muxed
MOVWF    CMCON        ; to 2 comps.
BSF      STATUS,RP0   ; go to Bank 1
MOVLW    0x07        ; RA3-RA0 are
MOVWF    TRISA        ; outputs
MOVLW    0xA6        ; enable VREF
MOVWF    VRCON        ; low range
                        ; set VR<3:0>=6
BCF      STATUS,RP0   ; go to Bank 0
CALL     DELAY10      ; 10µs delay
    
```

10.2 Voltage Reference Accuracy/Error

The full range of VSS to VDD cannot be realized due to the construction of the module. The transistors on the top and bottom of the resistor ladder network (Figure 10-1) keep VREF from approaching VSS or VDD. The Voltage Reference is VDD derived and therefore, the VREF output changes with fluctuations in VDD. The tested absolute accuracy of the Voltage Reference can be found in Table 17-2.

10.3 Operation During SLEEP

When the device wakes-up from SLEEP through an interrupt or a Watchdog Timer timeout, the contents of the VRCON register are not affected. To minimize current consumption in SLEEP mode, the Voltage Reference should be disabled.

10.4 Effects of a RESET

A device RESET disables the Voltage Reference by clearing bit VREN (VRCON<7>). This RESET also disconnects the reference from the RA2 pin by clearing bit VROE (VRCON<6>) and selects the high voltage range by clearing bit VRR (VRCON<5>). The VREF value select bits, VRCON<3:0>, are also cleared.

10.5 Connection Considerations

The Voltage Reference module operates independently of the Comparator module. The output of the reference generator may be connected to the RA2 pin if the TRISA<2> bit is set and the VROE bit, VRCON<6>, is set. Enabling the Voltage Reference output onto the RA2 pin with an input signal present will increase current consumption. Connecting RA2 as a digital output with VREF enabled will also increase current consumption.

The RA2 pin can be used as a simple D/A output with limited drive capability. Due to the limited drive capability, a buffer must be used in conjunction with the Voltage Reference output for external connections to VREF. Figure 10-2 shows an example buffering technique.

FIGURE 10-2: VOLTAGE REFERENCE OUTPUT BUFFER EXAMPLE

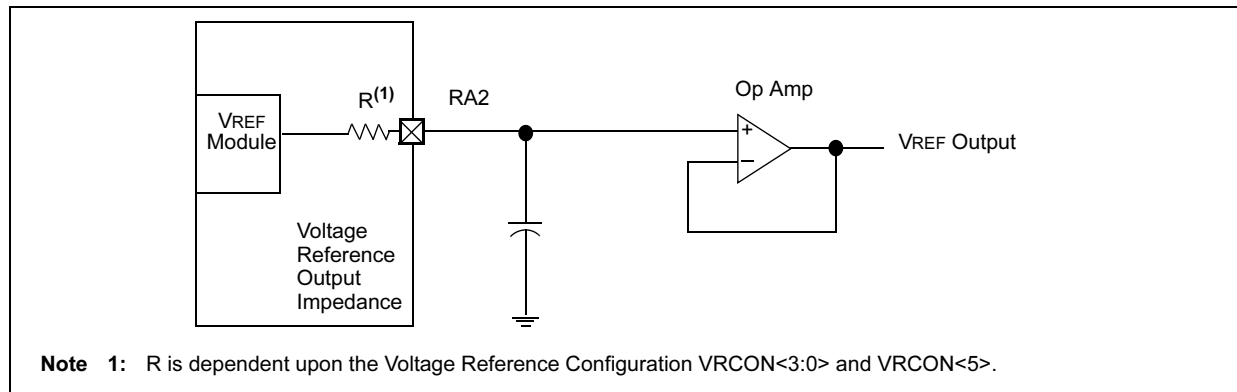


TABLE 10-1: REGISTERS ASSOCIATED WITH VOLTAGE REFERENCE

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value On POR	Value On All Other RESETS
9Fh	VRCON	VREN	VROE	VRR	—	VR3	VR2	VR1	VR0	000- 0000	000- 0000
1Fh	CMCON	C2OUT	C1OUT	C2INV	C1INV	CIS	CM2	CM1	CM0	0000 0000	0000 0000
85h	TRISA	TRISA7	TRISA6	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	1111 1111	1111 1111

Note 1: — = Unimplemented, read as '0'.

TABLE 12-4: BAUD RATES FOR ASYNCHRONOUS MODE (BRGH = 0)

BAUD RATE (K)	Fosc = 20 MHz			16 MHz			10 MHz		
	KBAUD	ERROR	SPBRG value (decimal)	KBAUD	ERROR	SPBRG value (decimal)	KBAUD	ERROR	SPBRG value (decimal)
0.3	NA	—	—	NA	—	—	NA	—	—
1.2	1.221	+1.73%	255	1.202	+0.16%	207	1.202	+0.16%	129
2.4	2.404	+0.16%	129	2.404	+0.16%	103	2.404	+0.16%	64
9.6	9.469	-1.36%	32	9.615	+0.16%	25	9.766	+1.73%	15
19.2	19.53	+1.73%	15	19.23	+0.16%	12	19.53	+1.73V	7
76.8	78.13	+1.73%	3	83.33	+8.51%	2	78.13	+1.73%	1
96	104.2	+8.51%	2	NA	—	—	NA	—	—
300	312.5	+4.17%	0	NA	—	—	NA	—	—
500	NA	—	—	NA	—	—	NA	—	—
HIGH	312.5	—	0	250	—	0	156.3	—	0
LOW	1.221	—	255	0.977	—	255	0.6104	—	255

BAUD RATE (K)	Fosc = 7.15909 MHz			5.0688 MHz			4 MHz		
	KBAUD	ERROR	SPBRG value (decimal)	KBAUD	ERROR	SPBRG value (decimal)	KBAUD	ERROR	SPBRG value (decimal)
0.3	NA	—	—	0.31	+3.13%	255	0.3005	-0.17%	207
1.2	1.203	+0.23%	92	1.2	0	65	1.202	+1.67%	51
2.4	2.380	-0.83%	46	2.4	0	32	2.404	+1.67%	25
9.6	9.322	-2.90%	11	9.9	+3.13%	7	NA	—	—
19.2	18.64	-2.90%	5	19.8	+3.13%	3	NA	—	—
76.8	NA	—	—	79.2	+3.13%	0	NA	—	—
96	NA	—	—	NA	—	—	NA	—	—
300	NA	—	—	NA	—	—	NA	—	—
500	NA	—	—	NA	—	—	NA	—	—
HIGH	111.9	—	0	79.2	—	0	62.500	—	0
LOW	0.437	—	255	0.3094	—	255	3.906	—	255

BAUD RATE (K)	Fosc = 3.579545 MHz			1 MHz			32.768 MHz		
	KBAUD	ERROR	SPBRG value (decimal)	KBAUD	ERROR	SPBRG value (decimal)	KBAUD	ERROR	SPBRG value (decimal)
0.3	0.301	+0.23%	185	0.300	+0.16%	51	0.256	-14.67%	1
1.2	1.190	-0.83%	46	1.202	+0.16%	12	NA	—	—
2.4	2.432	+1.32%	22	2.232	-6.99%	6	NA	—	—
9.6	9.322	-2.90%	5	NA	—	—	NA	—	—
19.2	18.64	-2.90%	2	NA	—	—	NA	—	—
76.8	NA	—	—	NA	—	—	NA	—	—
96	NA	—	—	NA	—	—	NA	—	—
300	NA	—	—	NA	—	—	NA	—	—
500	NA	—	—	NA	—	—	NA	—	—
HIGH	55.93	—	0	15.63	—	0	0.512	—	0
LOW	0.2185	—	255	0.0610	—	255	0.0020	—	255

14.5 Power-on Reset (POR), Power-up Timer (PWRT), Oscillator Start-up Timer (OST) and Brown-out Detect (BOD)

14.5.1 POWER-ON RESET (POR)

The on-chip POR circuit holds the chip in RESET until VDD has reached a high enough level for proper operation. To take advantage of the POR, just tie the MCLR pin through a resistor to VDD. This will eliminate external RC components usually needed to create Power-on Reset. A maximum rise time for VDD is required. See Electrical Specifications for details.

The POR circuit does not produce an internal RESET when VDD declines.

When the device starts normal operation (exits the RESET condition), device operating parameters (voltage, frequency, temperature, etc.) must be met to ensure operation. If these conditions are not met, the device must be held in RESET until the operating conditions are met.

For additional information, refer to Application Note AN607, "Power-up Trouble Shooting".

14.5.2 POWER-UP TIMER (PWRT)

The PWRT provides a fixed 72 ms (nominal) timeout on power-up only, from POR or Brown-out Detect Reset. The PWRT operates on an internal RC oscillator. The chip is kept in RESET as long as PWRT is active. The PWRT delay allows the VDD to rise to an acceptable level. A configuration bit, **PWRT**, can disable (if set) or enable (if cleared or programmed) the PWRT. The PWRT should always be enabled when Brown-out Detect Reset is enabled.

The Power-Up Time delay will vary from chip to chip and due to VDD, temperature and process variation. See DC parameters for details.

14.5.3 OSCILLATOR START-UP TIMER (OST)

The OST provides a 1024 oscillator cycle (from OSC1 input) delay after the PWRT delay is over. This ensures that the crystal oscillator or resonator has started and stabilized.

The OST timeout is invoked only for XT, LP and HS modes and only on Power-on Reset or wake-up from SLEEP.

14.5.4 BROWN-OUT DETECT (BOD) RESET

The PIC16F62X members have on-chip BOD circuitry. A configuration bit, **BODEN**, can disable (if clear/programmed) or enable (if set) the BOD Reset circuitry. If VDD falls below VBOD for longer than TBOD, the brown-out situation will RESET the chip. A RESET is not guaranteed to occur if VDD falls below VBOD for shorter than TBOD. VBOD and TBOD are defined in Table 17-1 and Table 17-6, respectively.

On any RESET (Power-on, Brown-out, Watchdog, etc.) the chip will remain in RESET until VDD rises above VBOD. The Power-up Timer will now be invoked and will keep the chip in RESET an additional 72 ms.

If VDD drops below VBOD while the Power-up Timer is running, the chip will go back into a Brown-out Detect Reset and the Power-up Timer will be re-initialized. Once VDD rises above VBOD, the Power-Up Timer will execute a 72 ms RESET. The Power-up Timer should always be enabled when Brown-out Detect is enabled. Figure 14-7 shows typical Brown-out situations.

FIGURE 14-7: BROWN-OUT SITUATIONS

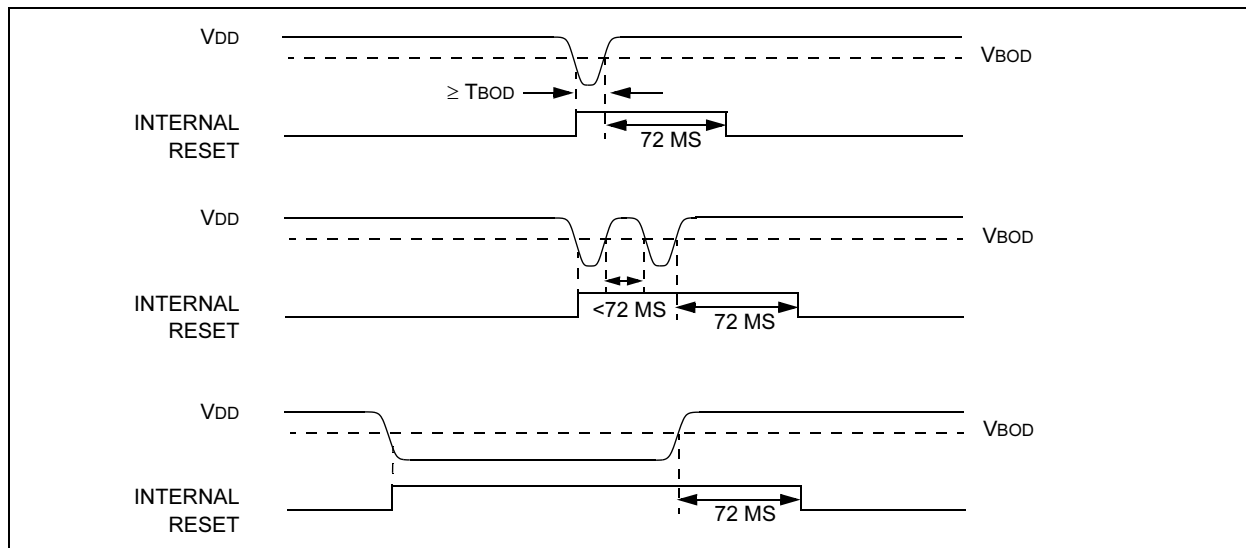


FIGURE 14-8: TIMEOUT SEQUENCE ON POWER-UP ($\overline{\text{MCLR}}$ NOT TIED TO V_{DD}): CASE

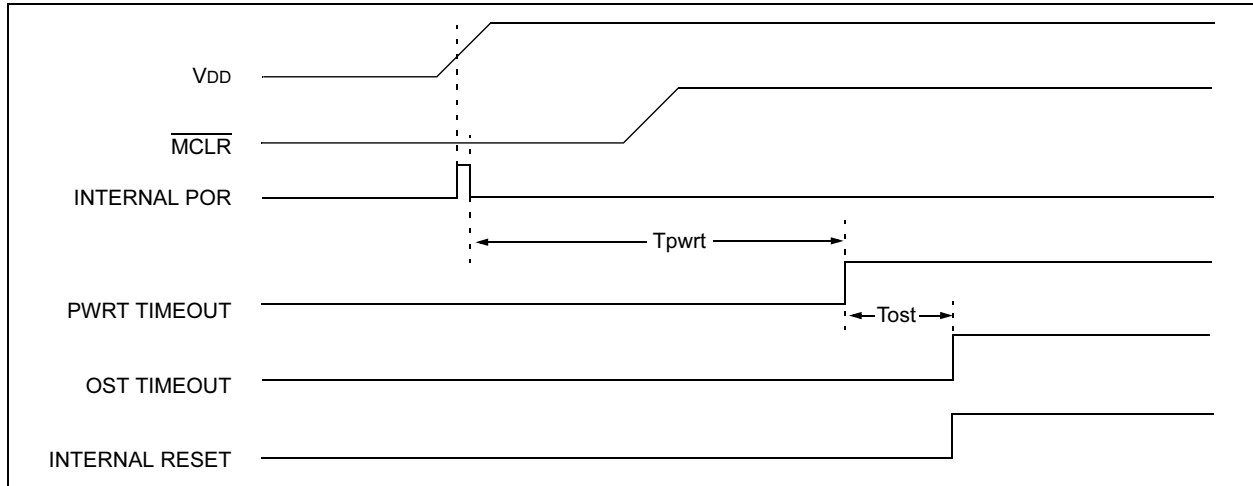


FIGURE 14-9: TIMEOUT SEQUENCE ON POWER-UP ($\overline{\text{MCLR}}$ NOT TIED TO V_{DD}): CASE 2

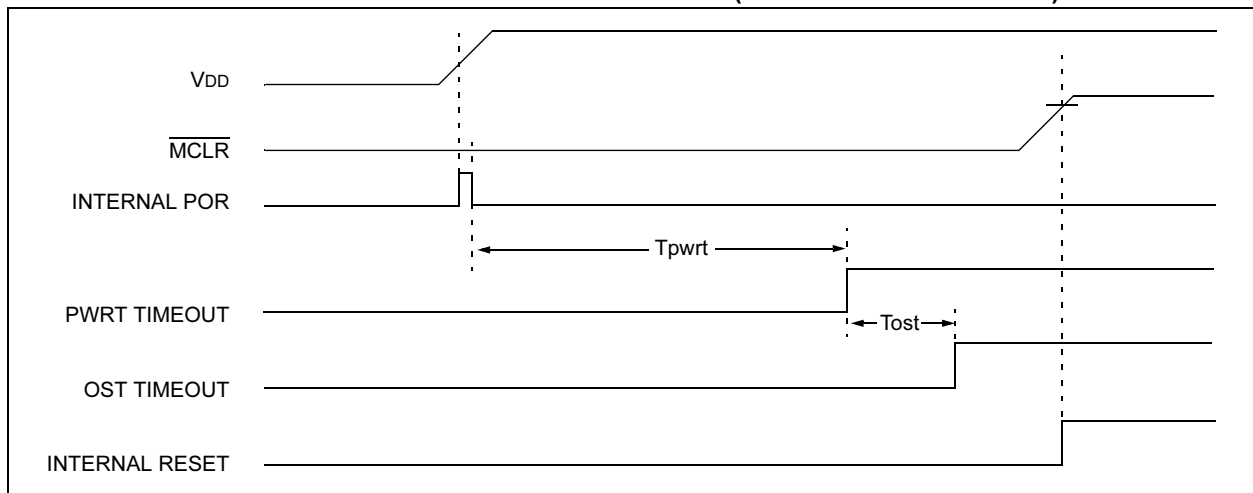
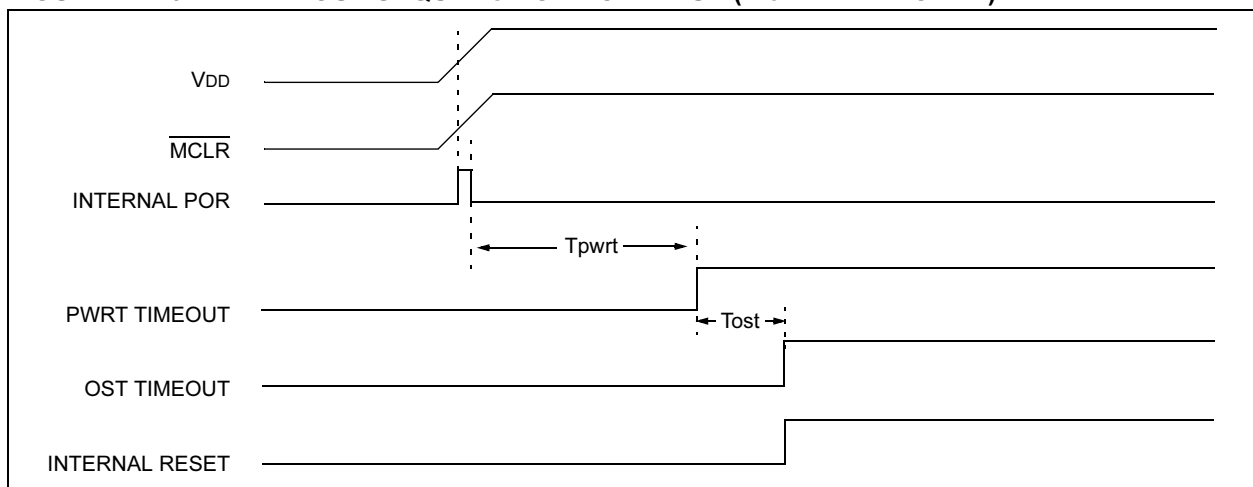


FIGURE 14-10: TIMEOUT SEQUENCE ON POWER-UP ($\overline{\text{MCLR}}$ TIED TO V_{DD})



IORLW Inclusive OR Literal with W

Syntax:	[<i>label</i>] IORLW k				
Operands:	0 ≤ k ≤ 255				
Operation:	(W) .OR. k → (W)				
Status Affected:	Z				
Encoding:	<table><tr><td>11</td><td>1000</td><td>kkkk</td><td>kkkk</td></tr></table>	11	1000	kkkk	kkkk
11	1000	kkkk	kkkk		
Description:	The contents of the W register is OR'ed with the eight bit literal 'k'. The result is placed in the W register.				
Words:	1				
Cycles:	1				
Example	IORLW 0x35 Before Instruction W = 0x9A After Instruction W = 0xBF Z = 0				

MOVLW Move Literal to W

Syntax:	[<i>label</i>] MOVLW k				
Operands:	$0 \leq k \leq 255$				
Operation:	$k \rightarrow (W)$				
Status Affected:	None				
Encoding:	<table border="1"><tr><td>11</td><td>00xx</td><td>kkkk</td><td>kkkk</td></tr></table>	11	00xx	kkkk	kkkk
11	00xx	kkkk	kkkk		
Description:	The eight bit literal 'k' is loaded into W register. The don't cares will assemble as 0's.				
Words:	1				
Cycles:	1				
Example	MOVLW 0x5A After Instruction W = 0x5A				

IORWF Inclusive OR W with f

Syntax:	[<i>label</i>] IORWF <i>f,d</i>				
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$				
Operation:	(W) .OR. (f) \rightarrow (dest)				
Status Affected:	Z				
Encoding:	<table border="1"><tr><td>00</td><td>0100</td><td>dfff</td><td>ffff</td></tr></table>	00	0100	dfff	ffff
00	0100	dfff	ffff		
Description:	Inclusive OR the W register with register 'f'. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.				
Words:	1				
Cycles:	1				
Example	IORWF REG1, 0 Before Instruction REG1 = 0x13 W = 0x91 After Instruction REG1 = 0x13 W = 0x93 Z = 1				

MOVF Move f

Syntax:	[<i>label</i>] MOVF f,d				
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$				
Operation:	(f) \rightarrow (dest)				
Status Affected:	Z				
Encoding:	<table><tr><td>00</td><td>1000</td><td>dfff</td><td>ffff</td></tr></table>	00	1000	dfff	ffff
00	1000	dfff	ffff		
Description:	The contents of register f is moved to a destination dependent upon the status of d. If d = 0, destination is W register. If d = 1, the destination is file register f itself. d = 1 is useful to test a file register since status flag Z is affected.				
Words:	1				
Cycles:	1				
Example	MOVF REG1, 0 After Instruction W = value in REG1 register Z = 1				


RETLW Return with Literal in W

Syntax:	[<i>label</i>] RETLW k				
Operands:	0 ≤ k ≤ 255				
Operation:	k → (W); TOS → PC				
Status Affected:	None				
Encoding:	<table border="1"><tr><td>11</td><td>01xx</td><td>kkkk</td><td>kkkk</td></tr></table>	11	01xx	kkkk	kkkk
11	01xx	kkkk	kkkk		
Description:	The W register is loaded with the eight bit literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a two-cycle instruction.				
Words:	1				
Cycles:	2				
Example	<pre>CALL TABLE;W contains table ;offset value • ;W now has table value TABLE • • ADDWF PC ;W = offset RETLW k1 ;Begin table RETLW k2 ; • • • RETLW kn ; End of table Before Instruction W = 0x07 After Instruction W = value of k8</pre>				

RETURN Return from Subroutine

Syntax:	[<i>label</i>] RETURN				
Operands:	None				
Operation:	TOS → PC				
Status Affected:	None				
Encoding:	<table border="1"><tr><td>00</td><td>0000</td><td>0000</td><td>1000</td></tr></table>	00	0000	0000	1000
00	0000	0000	1000		
Description:	Return from subroutine. The stack is POPed and the top of the stack (TOS) is loaded into the program counter. This is a two-cycle instruction.				
Words:	1				
Cycles:	2				
Example	RETURN After Interrupt PC = TOS				

RLF Rotate Left f through Carry

Syntax:	[<i>label</i>] RLF <i>f</i> , <i>d</i>				
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$				
Operation:	See description below				
Status Affected:	C				
Encoding:	<table><tr><td>00</td><td>1101</td><td>dfff</td><td>ffff</td></tr></table>	00	1101	dfff	ffff
00	1101	dfff	ffff		
Description:	<p>The contents of register 'f' are rotated one bit to the left through the Carry Flag. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is stored back in register 'f'.</p> 				
Words:	1				
Cycles:	1				
Example	<pre>RLF REG1, 0</pre> <p>Before Instruction</p> <pre> REG1 = 1110 0110 C = 0</pre> <p>After Instruction</p> <pre> REG1 = 1110 0110 W = 1100 1100 C = 1</pre>				

17.1 DC Characteristics: PIC16F62X-04 (Commercial, Industrial, Extended) PIC16F62X-20 (Commercial, Industrial, Extended) PIC16LF62X-04 (Commercial, Industrial)

PIC16LF62X-04 (Commercial, Industrial)			Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_a \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq T_a \leq +70^{\circ}\text{C}$ for commercial				
PIC16F62X-04 PIC16F62X-20 (Commercial, Industrial, Extended)			Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_a \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq T_a \leq +70^{\circ}\text{C}$ for commercial and $-40^{\circ}\text{C} \leq T_a \leq +125^{\circ}\text{C}$ for extended				
Param No.	Sym	Characteristic/Device	Min	Typ†	Max	Units	Conditions
D020	IPD	Power Down Current^{*(2), (3)}					
		PIC16LF62X	—	0.20	2.0	μA	$V_{DD} = 2.0$
D020		PIC16F62X	—	0.20	2.2	μA	$V_{DD} = 5.5$
			—	0.20	2.2	μA	$V_{DD} = 3.0$
			—	0.20	5.0	μA	$V_{DD} = 4.5^*$
			—	0.20	9.0	μA	$V_{DD} = 5.5$
			—	2.70	15.0	μA	$V_{DD} = 5.5$ Extended
D023	ΔI_{WDT}	WDT Current ⁽⁴⁾	—	6.0	15	μA	$V_{DD} = 3.0\text{V}$
	ΔI_{BOD}	Brown-out Detect Current ⁽⁴⁾	—	75	125	μA	$\overline{\text{BOD}}$ enabled, $V_{DD} = 5.0\text{V}$
	ΔI_{COMP}	Comparator Current for each Comparator ⁽⁴⁾	—	30	50	μA	$V_{DD} = 3.0\text{V}$
	ΔI_{VREF}	VREF Current ⁽⁴⁾	—		135	μA	$V_{DD} = 3.0\text{V}$
D023	ΔI_{WDT}	WDT Current ⁽⁴⁾	—	6.0	20	μA	$V_{DD} = 4.0\text{V}$, Commercial, Industrial
	ΔI_{BOD}	Brown-out Detect Current ⁽⁴⁾	—	75	25	μA	$V_{DD} = 4.0\text{V}$, Extended
	ΔI_{COMP}	Comparator Current for each Comparator ⁽⁴⁾	—	30	50	μA	$\overline{\text{BOD}}$ enabled, $V_{DD} = 5.0\text{V}$
	ΔI_{VREF}	VREF Current ⁽⁴⁾	—		135	μA	$V_{DD} = 4.0\text{V}$

Legend: Rows with standard voltage device data only are shaded for improved readability.

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C, unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which V_{DD} can be lowered in SLEEP mode without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all I_{DD} measurements in active Operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tri-stated, pulled to V_{DD} ,

MCLR = V_{DD} ; WDT enabled/disabled as specified.

3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to V_{DD} or V_{SS} .

4: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base I_{DD} or I_{PD} measurement.

5: For RC osc configuration, current through REXT is not included. The current through the resistor can be estimated by the formula $I_r = V_{DD}/2R_{EXT}$ (mA) with R_{EXT} in k Ω .

PIC16F62X

FIGURE 17-8: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING

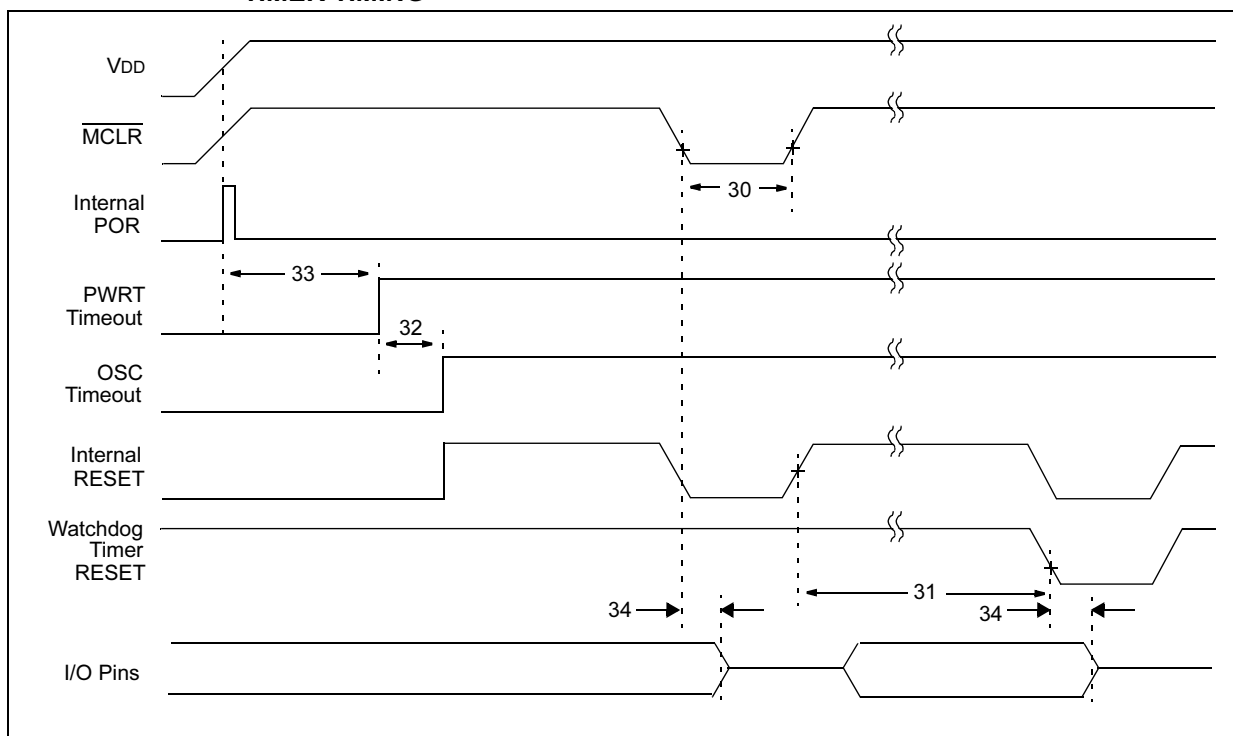


FIGURE 17-9: BROWN-OUT DETECT TIMING

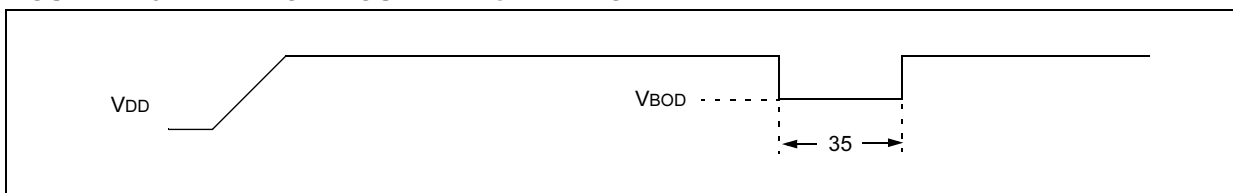


TABLE 17-6: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER REQUIREMENTS

Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
30	TmCL	MCLR Pulse Width (low)	2000 TBD	— TBD	— TBD	ns ms	VDD = 5V, -40°C to +85°C Extended temperature
31	Twdt	Watchdog Timer Timeout Period (No Prescaler)	7 TBD	18 TBD	33 TBD	ms ms	VDD = 5V, -40°C to +85°C Extended temperature
32	Tost	Oscillation Start-up Timer Period	—	1024Tosc	—	—	Tosc = OSC1 period
33*	Tpwrt	Power-up Timer Period	28 TBD	72 TBD	132 TBD	ms ms	VDD = 5V, -40°C to +85°C Extended temperature
34	TIOZ	I/O Hi-impedance from MCLR Low or Watchdog Timer Reset	—	—	2.0	μs	
35	TBOD	Brown-out Detect pulse width	100	—	—	μs	VDD ≤ VBOD (D005)

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note: The graphs and tables provided in this section are for design guidance and are not tested.

**FIGURE 18-12: $\Delta I_{TMR1OSC}$ vs V_{DD} OVER TEMP (0°C to +70°C)
SLEEP MODE, TIMER1 OSCILLATOR, 32 kHz XTAL**

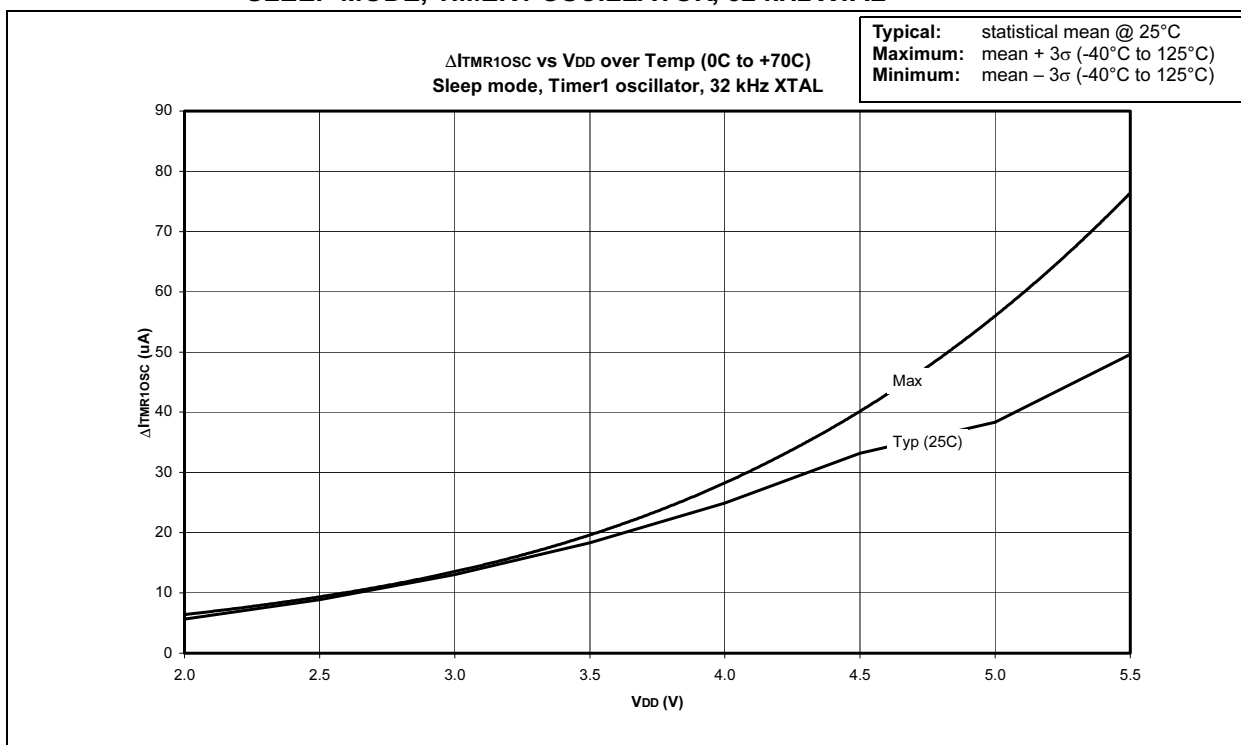
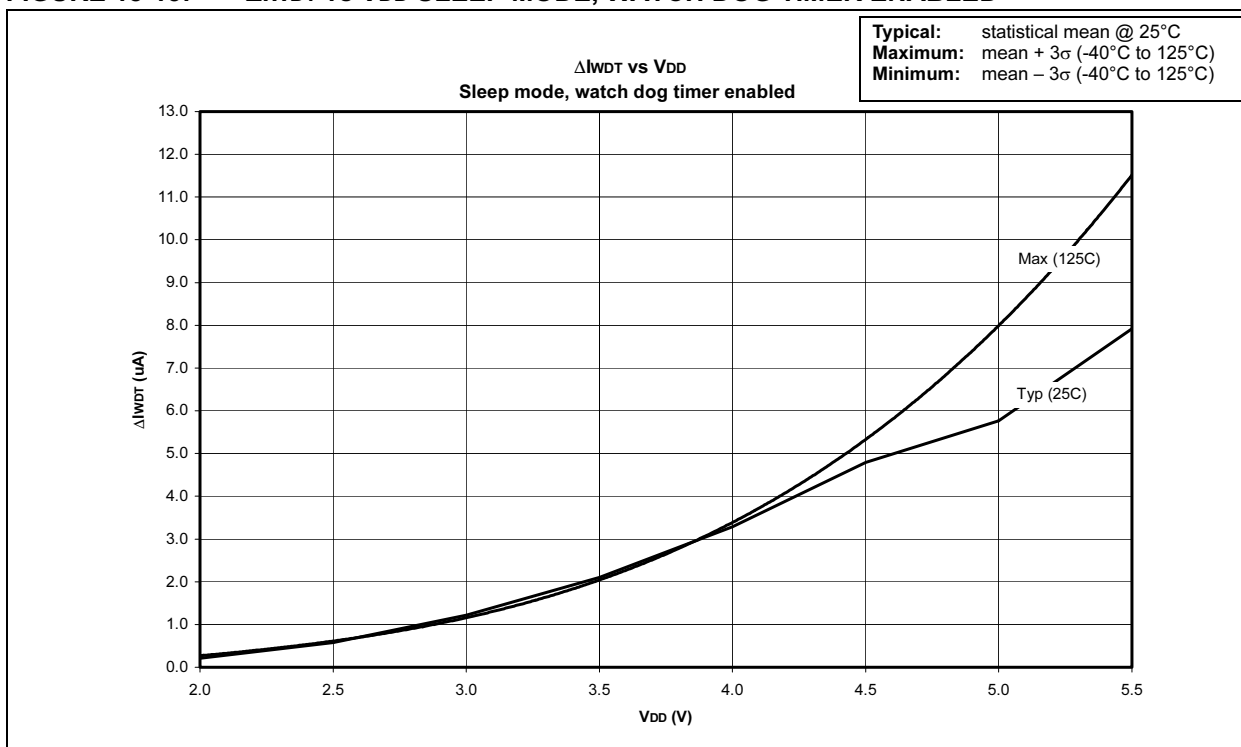


FIGURE 18-13: ΔI_{WDT} vs V_{DD} SLEEP MODE, WATCH DOG TIMER ENABLED



Note: The graphs and tables provided in this section are for design guidance and are not tested.

FIGURE 18-20: VOL vs IOL OVER TEMP (C) VDD = 5V

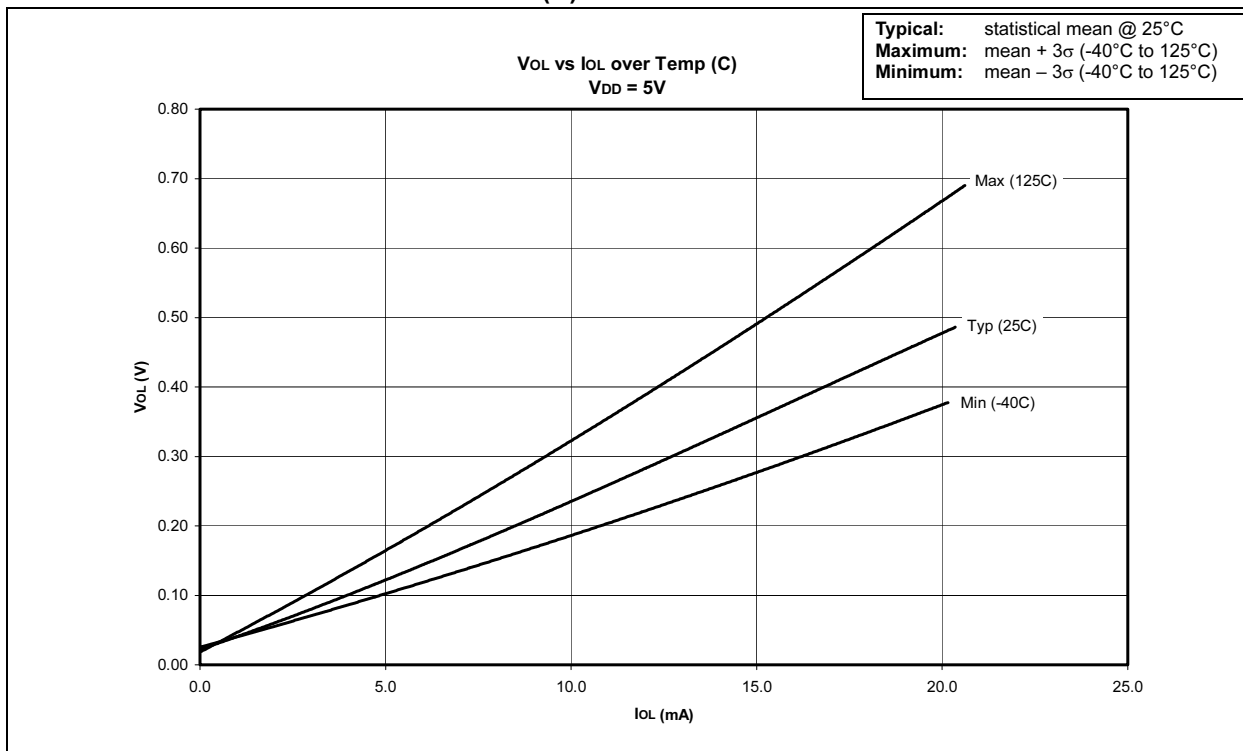
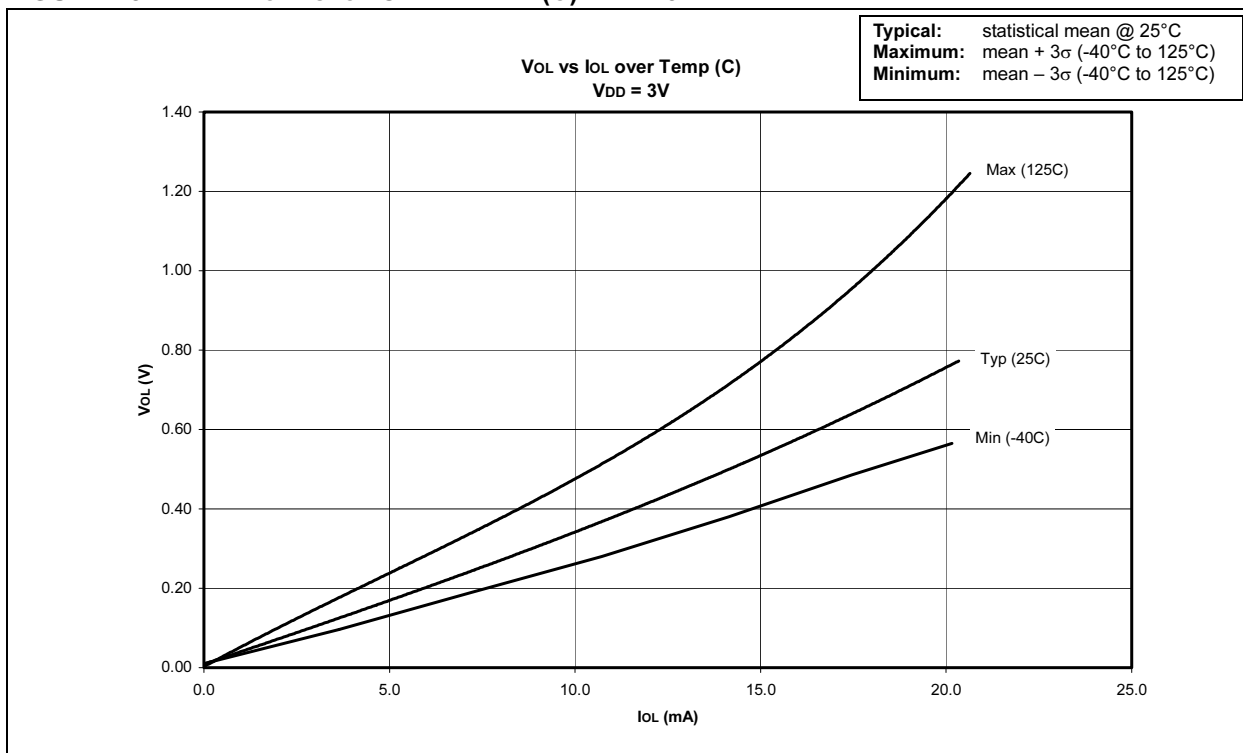


FIGURE 18-21: VOL vs IOL OVER TEMP (C) VDD = 3V



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